

C1206F225K4RACTU

Aliases (C1206F225K4RAC7800) SMD Comm X7R FO, Ceramic, 2.2 uF, 10%, 16 VDC, X7R, SMD, MLCC, Open Mode, Temperature Stable, 1206, 1.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X7R FO
Style	SMD Chip
Description	SMD, MLCC, Open Mode, Temperature Stable
Features	Open Mode, Temperature Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	25 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		Sp
Chip Size	1206	Ca
L	3.2mm +/-0.2mm	Me
W	1.6mm +/-0.2mm	Tol
т	0.9mm +/-0.20mm	Vol
S	1.5mm MIN	Die
В	0.5mm +/-0.25mm	Ter
		т

Packaging Specifications

Packaging Ta	F&R, 180mm, Plastic Tape
Packaging Quantity 4	1000

Specifications	
Capacitance	2.2 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	16 VDC
Dielectric Withstanding Voltage	40 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	3.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	227.3 MOhms

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